P-Channel Enhancement Mode Power MOSFET

DESCRIPTION

The JRM12P03 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V.

GENERAL FEATURES

• $V_{DS} = -30V, I_{D} = -20A$

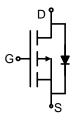
 $R_{DS(ON)} < 25 m\Omega$ @ V_{GS} =-4.5V

 $R_{DS(ON)} < 15 m\Omega$ @ V_{GS} =-10V

- High Power and current handing capability
- Lead free product is acquired
- Surface Mount Package

Application

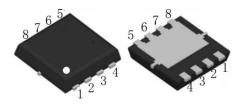
- Battery Switch
- ●Load Switch
- Power Management



Schematic diagram



Marking and pin Assignment



PDFN3.3*3.3 top view

Package Marking And Ordering Information

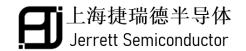
Device Marking	Ordering Codes	Package	Product Code	Packing
M12P03	JRM12P03-R	PDFN 3.3*3.3	JRM12P03	Reel

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	-30	V	
Gate-Source Voltage		V _G s	±20	V	
Drain Current-Continuous		I _D	-20	А	
Drain Current-Pulsed	(Note 1)	I _{DM}	-80	А	
Maximum Power Dissipation(Tc=25°C)		D	10.6	W	
Maximum Power Dissipation(Tc=100°C)		P_{D}	6.4		
Single pulse avalanche energy	(Note 2)	Eas	171	mJ	
Operating Junction and Storage Temperature Range		T_{J} , T_{STG}	-55 To 150	°C	

Thermal Characteristic

Thermal Resistance,Junction-to-Case	Rejc	11.8	°C/W	
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	40	°C/W	



Electrical Characteristics (TA=25°C unless otherwise noted)

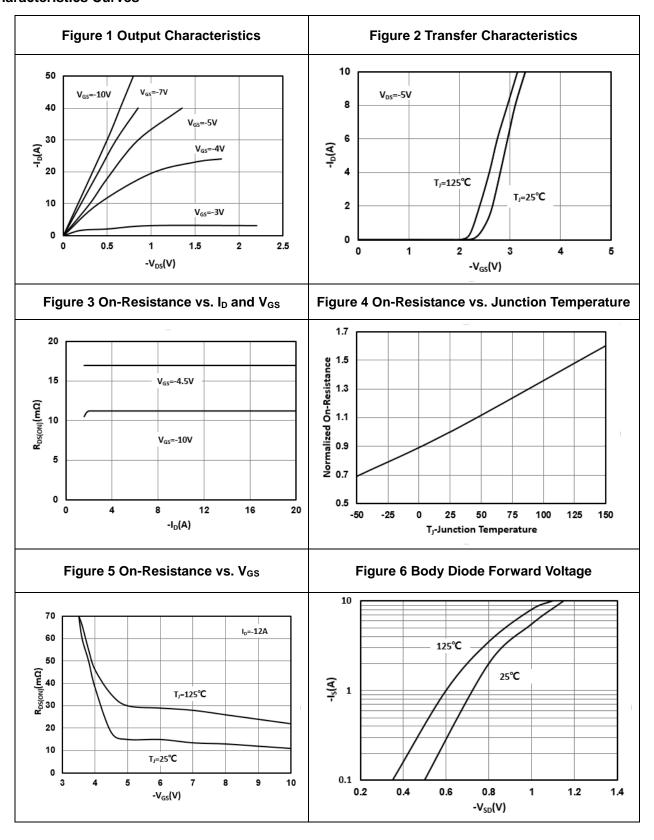
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-30	-33	-	V
Zero Gate Voltage Drain Current	IDSS	V _{DS} =-30V,V _{GS} =0V	-	-	-1	μA
Gate-Body Leakage Current	Igss	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250µA	-1	-1.5	-3	V
Drain-Source On-State Resistance (Note 3)	-	V _{GS} =-10V, I _D =-10A	-	11.5	15	mΩ
Drain-Source On-State Resistance (Note 3)	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-10A	-	18	25	mΩ
Forward Transconductance	g FS	V _{DS} =-10V,I _D =-12A	16	-	-	S
Dynamic Characteristics						
Input Capacitance	Clss	V 451414 014	-	2628	-	PF
Output Capacitance	Coss	V_{DS} =-15V, V_{GS} =0V, F=1.0MHz	-	294	-	PF
Reverse Transfer Capacitance	Crss	F=1.UIVID2	-	271	-	PF
Switching Characteristics						
Turn-on Delay Time	t _{d(on)}		-	9	-	nS
Turn-on Rise Time	tr	V _{DD} =-15V, ID=-10A,	-	8	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10 V , R_{GEN} =1 Ω	-	28	-	nS
Turn-Off Fall Time	t _f			10	-	nS
Total Gate Charge	Qg	V 20VI 20A	-	55.3	-	nC
Gate-Source Charge	Q_{gs}	V _{DS} =-30V,I _D =-20A	-	7.9	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} =-10V		11.3	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V_{SD}	V _{GS} =0V,I _S =-12A	-	-	-1.2	V

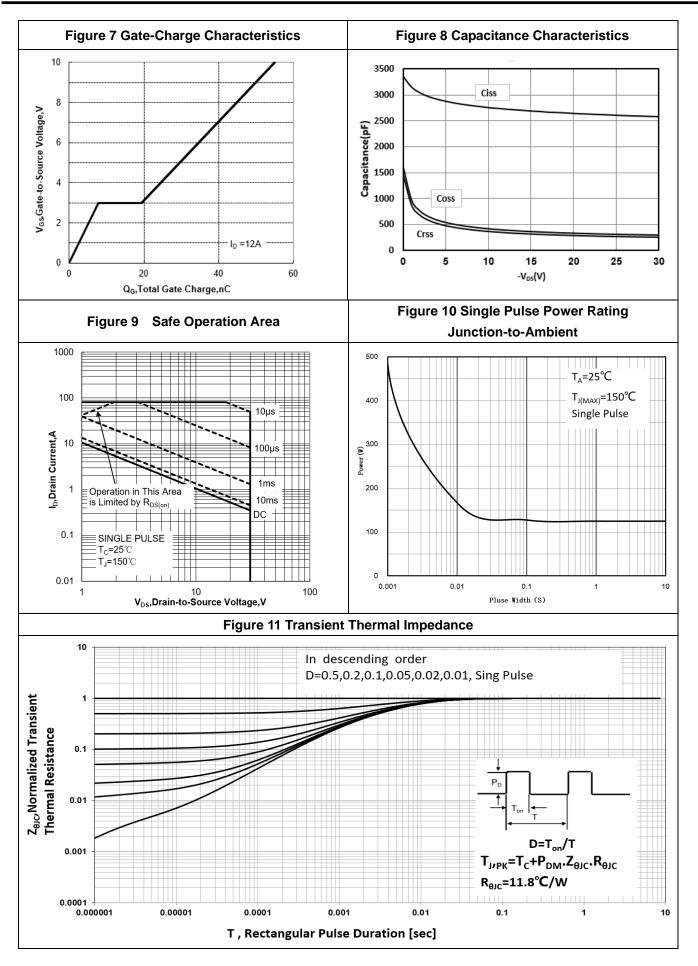
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. $I_{AS} = -34A$, $V_{DD} = -30V$, $R_G = 25\Omega$, Starting $T_j = 25^{\circ}C$. 3. Pulse Test: Pulse Width $\leq 300\mu$ s, Duty Cycle $\leq 2\%$.



Characteristics Curves

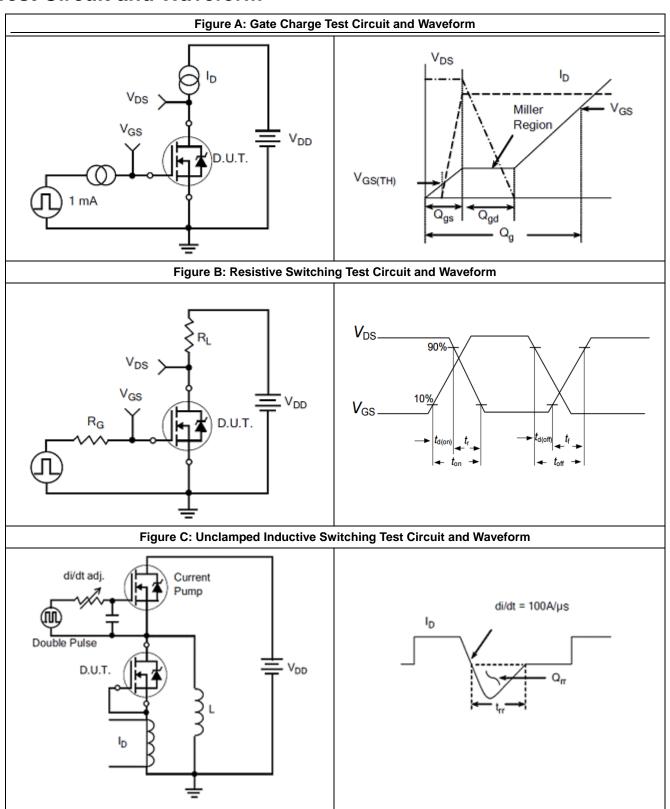


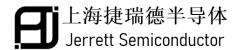






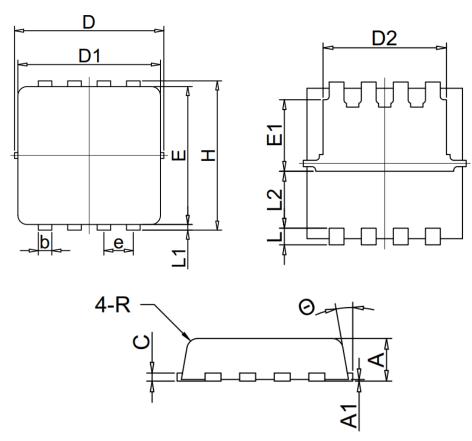
Test Circuit and Waveform







Package



SYMBOL	MIN	NOM	MAX	
Α	0.70	0.80	0.90	
A1	0.00	0.03	0.05	
b	0.24	0.30	0.35	
С	0.152REF			
D	3.25	3.32	3.40	
D1	3.05	3.15	3.25	
D2	2.40	2.50	2.60	
E	3.00	3.10	3.20	
E1	1.35	1.45	1.55	
е	0.65BSC			
Н	3.20	3.30	3.40	
L	0.30	0.40	0.15	
L1	0.10	0.15	0.20	
L2	1.13REF			
R	0.20REF			
θ	6°	10°	14°	

PDFN 3.3*3.3 Package





NOTE:

- 1. Exceeding the maximum ratings of the device in performance may cause damage to the device, even the permanent failure, which may affect the dependability of the machine. Please do not exceed the absolute maximum ratings of the device when circuit designing.
- **2.** When installing the heat sink, please pay attention to the torsional moment and the smoothness of the heat sink.
- **3.** MOSFETs is the device which is sensitive to the static electricity, it is necessary to protect the device from being damaged by the static electricity when using it.
- **4.** Shanghai Jerrett reserves the right to make changes in this specification sheet and is subject to change without prior notice.